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6.78 MHz Wireless Power Transfer with Self-Resonant Coils at 95% DC-DC Efficiency

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Abstract—MHz-frequency inductive wireless power transfer holds the promise of compact and efficient wireless power transfer. Unfortunately, due to high-frequency losses in wide-bandgap semiconductors and low- Q high-frequency coil designs, these systems are universally less efficient, on a dc-dc basis, than wireless power systems operating at conventional frequency regimes. This letter describes the design considerations for inductive wireless power transfer systems operating at 6.78 MHz. With a novel high-frequency resonant amplifier topology, a high- Q self-resonant coil structure, and a better understanding of C_{oss} losses in wide-bandgap power semiconductors, we demonstrate 6.78 MHz wireless power transfer systems that achieve 95 % dc-dc efficiency at power levels up to and beyond 1 kW.

I. INTRODUCTION

Inductive wireless power transfer (WPT) has the potential to improve the convenience, cost, and utilization of battery-powered systems, including electric vehicles, medical implants, and robotics for warehouse automation. Wireless chargers typically operate with a switching frequency of 20 kHz–200 kHz [1], [2], resulting in electromagnetic coils that dominate the cost, weight, size, and losses of the wireless charging system [3]. Increasing the frequency has the potential to improve coil power density, efficiency, and cost through the increase in coil quality factor expected with higher frequency [4], and beyond 200 kHz, the international, scientific, and medical (ISM) band of 6.78 MHz is an attractive frequency of operation from a regulatory and standardization perspective [5].

Winding loss is a critical, and often dominant, component of the power losses in the WPT coils. One promising avenue to decrease winding loss is by increasing the switching frequency (f_{sw}), where the quality factor (Q) is expected to increase with f_{sw} [6]. More tangibly: if the conductors are fully utilized, increasing the switching frequency from 200 kHz to 6.78 MHz would allow $33\times$ less copper to be used to achieve the same performance – or, alternatively, the same amount of fully-utilized copper could increase Q by the identical $33\times$ factor (or winding loss would no longer dominate the coil losses). At MHz frequencies, further, the benefit of using litz wire is limited [7], and the cost of the coils can be reduced by replacing litz wire with solid wire or thin foil layers. With emerging wide-bandgap (WBG) power semiconductors, like GaN and SiC, that have excellent $R_{DS,on} * Q_g$ figures-of-merit (FOM) relative to Si devices [8], the high-frequency inverter and rectifier may also operate with high-efficiency, even at MHz frequencies. With the coils improved at high-frequency and new power electronics devices and topologies enabling

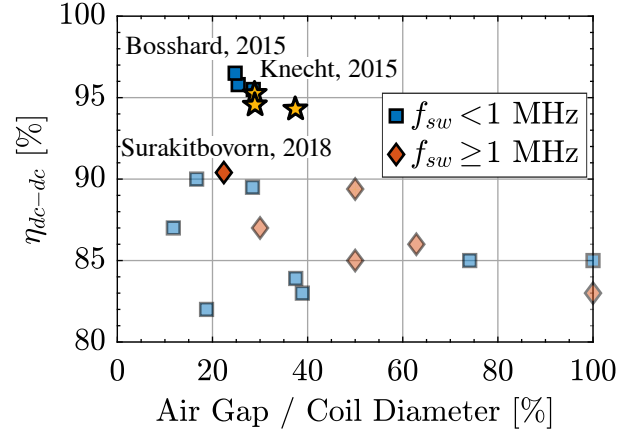


Fig. 1: Dc-dc efficiency for state-of-the-art (SOA) WPT. Existing systems with switching frequencies below 1 MHz achieve dc-dc efficiencies over 95 %, but prior multi-MHz designs had only reached 90 %, a $2\times$ increase in losses for a similar coupling coefficient. This work (*) realizes highly-efficient (> 95 %) and ultra-compact dc-dc WPT converters at 6.78 MHz and over 1 kW output power. Directly cited work is [9]–[12], and backgrounded SOA is [13]–[22] and two commercial systems, WiTricity ICS115 and D-Broad Core.

fast switching operation, the promise of high-efficiency and compact dc-dc MHz WPT systems can be realized.

Despite this potential, the high-frequency promise hasn't been realized in WPT, as shown in the survey of existing WPT dc-dc converters of Fig. 1. Only a single system with an f_{sw} above 1 MHz has achieved a dc-dc efficiency above 90 % [12], nearly $2\times$ higher losses than the highly-efficient performance in the 20 kHz–200 kHz switching range (95 %) [10], [11]. These low reported efficiencies are due to two primary drivers: high-frequency design challenges in the inverter and rectifier, where power semiconductor losses – even with soft-switching – are much higher-than-expected [23], [24], and low- Q coils and resonant tanks at MHz frequencies [22].

In this Letter, we take on all of these challenges – combining new topologies [25]–[28], state-of-the-art coils [29], and a deep understanding of high-frequency losses in power semiconductors [23], [30] – to showcase two benchmark-setting 6.78 MHz wireless power systems with a best-in-class dc-dc efficiency of 95 % at maximum output power levels of 300 W and 1 kW. These new benchmarks, which are $2\times$ lower losses than the best existing multi-MHz WPT systems, indicate that, with careful design of both power electronics and electromagnetics, the promise of increased frequency can be realized in ultra-compact and highly-efficient wireless power links to power the electric, automated future of logistics (robots, drones) and transportation (scooters, electric vehicles).

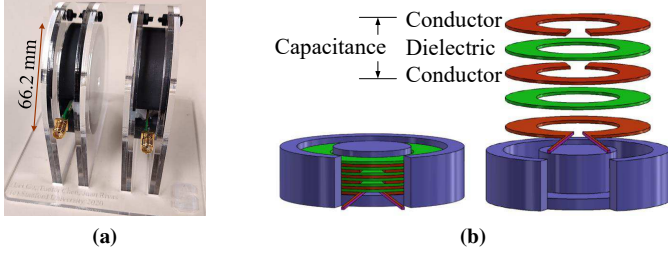


Fig. 2: Implemented coils in this Letter. (a) Coils, with a diameter of 6.6 cm. (b) Multi-layer self-resonant structure (MSRS) internal architecture, with an integrated capacitance and thin foil layers [29].

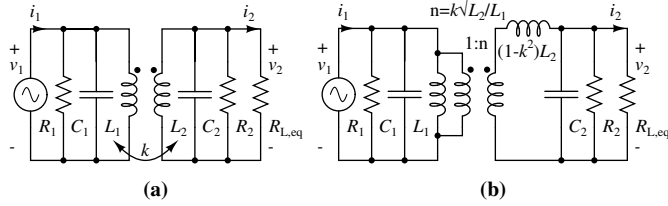


Fig. 3: Coupled parallel-compensated coils circuit model. (a) Coupled circuit model. (b) Cantilever model.

II. PARALLEL-COMPENSATED COIL CONSIDERATIONS

Recently, an integrated WPT coil design - where the compensation capacitance is embedded into the winding of the coil - was published in [29], which achieves a Q that is $6\times$ higher than the best conventional designs (with similar dimensions) at 6.78 MHz. The coil architecture, which is shown in Fig. 2 and termed the multi-layer self-resonant structure (MSRS), utilizes the compensation capacitance to force equal current sharing among multiple thin foil layers, mitigating both the skin and proximity effects that typically drive winding losses at multi-MHz frequencies. Although this coil achieves a very-high quality factor, the structure is inherently parallel-compensated. There are limited publications that discuss a parallel-parallel (PP) compensated design (versus the more standard series-series or series-parallel compensation strategies [31]), and this section focuses on the design of the WPT system around this parallel-compensated architecture.

Parallel-compensated coils can be modeled as shown in Fig. 3. The cantilever model of Fig. 3b is simple to measure and understand [32], while the coupled-coil model in Fig. 3a gives more insight to the circuit operation. The lumped resistances R_1 and R_2 model the total losses of the respective resonant tanks. Because the compensation capacitance C_1 and C_2 are in parallel with the resonator terminals, the voltage across the two tanks cannot change instantaneously, preventing the use of voltage-mode inverter and rectifier circuits.

A current-mode rectifier is suitable to rectify the output of a parallel-compensated coil on the secondary side, as shown in Fig. 4. Here the current-mode rectifier has a choke inductor output filter L_o ¹, and the dc output current can be approximated as constant. In the current-mode rectifier, the ac voltage has low distortion and is close to a sine wave and the ac current is a square wave.

¹ A voltage-mode rectifier only has a capacitive output filter and works with series-compensated coils

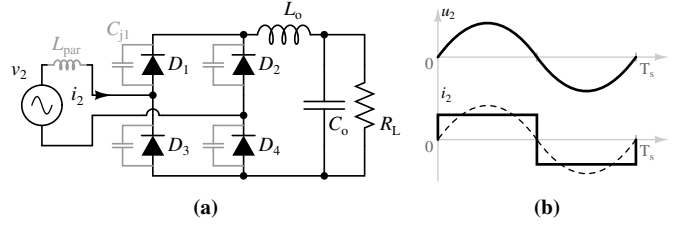


Fig. 4: Current-mode rectifier. (a) Circuit. (b) Ideal waveform.

Ideally, a current-mode rectifier can be modeled as an equivalent resistance with a value of $R_{L,eq} = \frac{\pi^2}{8} R_L$ [32], but the junction capacitance of the diodes makes the effective input impedance slightly capacitive. This part of the capacitive impedance must be considered and calculated, and when known, can be incorporated into the compensation capacitance C_2 . This capacitive impedance, however, depends on the large-signal behavior of the rectifier and does not simply equal the sum of the small-signal junction capacitance of the diodes.

To achieve the maximum wireless link efficiency of [33], the compensation capacitance must correctly resonate with the coil inductance. For PP compensation, the relationship between the inductances and the capacitances of the coils is:

$$C_1 = \frac{1}{\omega_0^2 L_1 (1 - k^2)} \quad C_2 = \frac{1}{\omega_0^2 L_2 (1 - k^2)}, \quad (1)$$

where the capacitance is selected to cancel the leakage inductance on each side. Practically, these can be quickly tuned by ensuring that L and C resonate at the switching frequency with the opposite coil terminals shorted.

P_1 , P_2 , and P_{loss} are the input, output power, and the total losses of the wireless link. Q_1 and Q_2 are the quality factors of the coils,

$$Q_1 = \frac{R_1}{\omega_0 L_1}, \quad Q_2 = \frac{R_2}{\omega_0 L_2}. \quad (2)$$

We define the load matching factor γ as the ratio between the secondary-side coil impedance and the equivalent ac load resistance:

$$\gamma = \frac{\omega_0 L_2}{R_{L,eq}}. \quad (3)$$

For a design using Eqn. (1), we can calculate the total loss factor $\lambda = P_{loss}/P_2$ as

$$\lambda = \frac{1}{\gamma Q_2} + \frac{(1 - k^2)^2}{k^2} \frac{1}{\gamma Q_1} \left(\gamma + \frac{1}{Q_2} \right)^2. \quad (4)$$

Further, the maximum WPT link efficiency is achieved when λ is minimum, so the load must be optimized relative to the impedance of the receive coil as:

$$\gamma_{opt} = \frac{1}{Q_2} \sqrt{1 + \left(\frac{k}{1 - k^2} \right)^2 Q_1 Q_2}. \quad (5)$$

With high Q coils, $kQ_1, kQ_2 \gg 1$,

$$\gamma_{opt} \approx \sqrt{\frac{Q_1}{Q_2}} \frac{k}{1 - k^2}. \quad (6)$$

If symmetric coils are used, the quality factors will be similar,

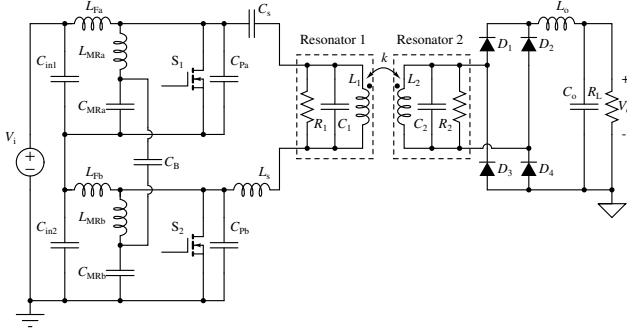


Fig. 5: Schematic of the PPT Φ_2 wireless dc-dc converter.

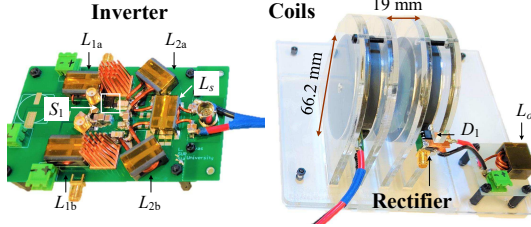


Fig. 6: Photograph of the PPT Φ_2 wireless dc-dc converter. Coil diameter is 66.2 mm and the separation between the closest part of the coils is 19 mm. Implemented inverter dimensions are 7 cm x 7 cm x 1 cm. Diodes are integrated on coil output terminal for low parasitic inductance.

$Q_1 \approx Q_2$, the optimal load matching factor becomes

$$\gamma_{\text{opt}} \approx \frac{k}{1 - k^2}. \quad (7)$$

In the following sections, we showcase this understanding of driving and rectifying these high- Q , parallel-compensated, self-resonant coils with two candidate inverter topologies showcasing high-efficiency ($>95\%$), 6.78 MHz wireless power transfer with both legacy Si MOSFETs and next-generation GaN power semiconductors.

III. A 300 W SYSTEM USING A NOVEL Φ_2 AMPLIFIER

As mentioned earlier, the voltage across the primary coil cannot change instantaneously due to the parallel compensation. The resonant inverter needs to behave more like a power amplifier, where the output voltage has low harmonic distortion, and a conventional half-bridge circuit cannot drive a parallel resonator directly (unlike for series-compensated coils). In the following sections, we introduce two high-efficiency amplifier topologies that are suitable for driving parallel-compensated primary coils.

Ref. [25], [34] introduced a novel push-pull Φ_2 amplifier topology that uses a T network for impedance tuning, which is termed a PPT Φ_2 amplifier. The amplifier achieves both low switch voltage stress and simplicity of gate driving. Fig. 5 shows the schematic of the PPT Φ_2 amplifier driving the parallel-compensated coils and a current-mode rectifier. With a series-stacked structure, S_1 and S_2 have a peak voltage stress of $1.05V_i$, much lower than the stress of a conventional Class-E [35] ($3.6V_i$) and its variants like the Class-EF₂ [36] ($2.1V_i$). The voltage on $C_{\text{in}1}$ and $C_{\text{in}2}$ is half of the input $0.5V_i$ and is automatically balanced because of the push-pull operation between S_1 and S_2 . The source of S_1 is referred to a constant dc potential ($0.5V_i$) that simplifies the gate drive implementation relative to a half-bridge circuit.

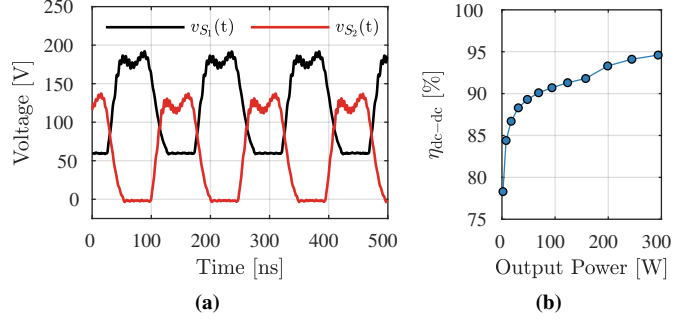


Fig. 7: PPT Φ_2 wireless prototype experimental (a) drain voltage waveform and (b) efficiency performance. Gate driving losses excluded. Power varied by adjust input voltage.

TABLE I: BILL OF MATERIALS, PPT Φ_2 WPT DC-DC CONVERTER

Device Symbols	Component Description
$S_{1,2}$	Infineon BSC160N15NS5 150 V Si MOSFET
D_{1-4}	STMicro STPSC406B-TR 650 V SiC Schottky
L_{Fa}, L_{Fb}	1.46 μH , Fair-rite 67 EEQ20/9
L_{MRa}, L_{MRb}	297 nH, Fair-rite 67 EEQ20/9
C_{MRa}, C_{MRb}	451 pF, C0G ceramic, 500 V
C_{Pa}, C_{Pb}	S_1 $C_{oss} + 630$ pF, C0G ceramic, 500 V
L_s	1.1 μH , Fair-rite 67 EEQ20/13
C_s	550 pF, C0G ceramic, 200 V
L_o	7 μH , Ferroxcube E22/6/16-4F1

The PPT Φ_2 can maintain zero-voltage-switching (ZVS) operation across a wide resistive load range, which is advantageous for driving the parallel-compensated WPT coils. At the resonant frequency, the input impedance to the coils stays resistive across variable output loads. Table I lists the key components for the 300 W Φ_2 wireless dc-dc converter, and Table II lists the parameters of the WPT coils. The prototype uses 150 V Si MOSFETs and 650 V SiC Schottky diodes. Using low-voltage Si trench MOSFETs eliminates the additional C_{oss} and dynamic on-resistance losses in high-voltage GaN FETs at MHz frequencies [23], [30]. Among the available Si and SiC diodes we tested [24], we selected the SiC Schottky diode with the least total conduction and C_{oss} losses for this voltage and power level. The equivalent large-signal capacitance of the rectifier is roughly 175 pF at 120 V_{out}. At a separation of 19 mm, the coupling between the coils is $k = 0.15$, a low coupling compared to many of the state-of-the-art shown in Fig. 1. Fig. 7 shows the measured drain node voltage waveform and efficiency performance of the prototype, with the converter continuously delivering 300 W from 120 V_{in} to 120 V_{out} with a dc-dc efficiency of 94.6% at 6.78 MHz.

With this proof-of-concept of ultra-high-efficiency 6.78 MHz wireless power even with legacy Si MOSFETs, we move to extend the power to the kW-scale with an alternate inverter topology and modern wide-bandgap power semiconductors.

IV. 1 kW SYSTEM USING A CLASS-D AMPLIFIER

Another MHz-frequency amplifier suitable for driving parallel-compensated coils is the Class-D amplifier with a high- Z series tank. Fig. 8 shows the schematic of the Class-D

TABLE II: MSRS COIL PARAMETERS

L_1 [H]	C_1 [F]	R_1 [Ω]	Q_1	L_2 [H]	C_2 [F]	R_2 [Ω]	Q_2
166.5n	3.32n	5.02k	708	159.3n	3.36n	4.84k	713

TABLE III: BILL OF MATERIALS, CLASS-D WPT DC-DC CONVERTER

Device Symbols	Component Description
$S_{1,2}$	GaN Systems GS66508P 650 V GaN FET
D_{1-4}	STMicro STPSC406B-TR x2 650 V SiC Schottky
L_s	950 nH, Ferroxcube E58/11/38-4F1
C_s	8 nF, COG ceramic, 1500 V
L_o	7 μ H, Ferroxcube E22/6/16-4F1

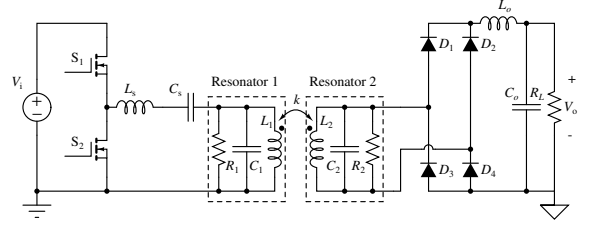
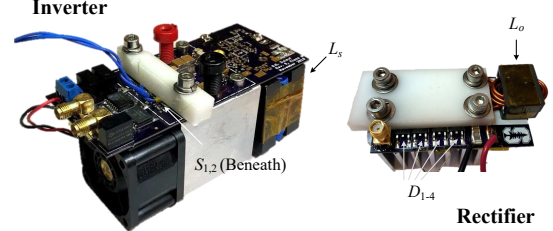
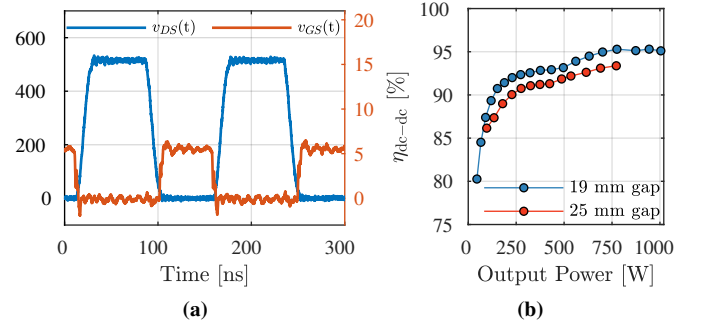
amplifier to drive the parallel coils, and a current-mode rectifier for the high-frequency rectification. Because of the shunt capacitance, the series filter L_s - C_s is necessary to remove the high-frequency harmonics, help achieve ZVS operation, and make the drive appear more “current-mode-like” to the shunt capacitances of the parallel-compensated coils.

Fig. 9 shows the photograph of the prototype converter, with Table III detailing the key implemented components and the same coils as those in Fig. 2 and Table II (with a slight adjustment to the compensation capacitance) used here. The Class-D implementation uses 650 V GaN FETs and 650 V SiC Schottky diodes (2 in parallel for each diode), with the specific GaN and SiC devices selected to minimize the total device losses, including the large C_{oss} losses at this frequency and voltage level [23], [24] and the dynamic on-resistance losses [30]. The inclusion of C_{oss} losses and dynamic R_{on} effect pushes the preferred operating point to have lower current and lower dV/dt to reduce both conduction and C_{oss} losses.

Fig. 10a shows the drain node at 525 V_{in} , where we observe ZVS, and Fig. 10b shows the measured dc-dc efficiency of the prototype as the power level is increased by increasing the input voltage. The prototype delivers 1 kW continuous power from 525 V_{in} to 225 V_{out} with a dc-dc efficiency of 95.1 % at 6.78 MHz, with a peak efficiency of 95.3 % at 943 W continuous output power. The equivalent large-signal input capacitance of the rectifier is roughly 330 pF at 223 V_{out} . Again, multi-MHz wireless power transfer is shown to achieve dc-dc efficiencies comparable to systems operating at conventional frequencies, even as the power is increased to the kW-scale with an eye towards charging the drones, scooters, robots, and electric vehicles of the logistics and transportation futures.

V. CONCLUSION

High-frequency wireless power transfer can be more cost-effective and compact than conventional litz-based, kHz-frequency WPT systems, but the efficiency of existing MHz-frequency systems has been limited by both poorly-understood power semiconductor losses and low- Q coil designs, and the losses at MHz-frequencies have been about $2\times$ higher than comparable systems in the kHz regime. In this Letter, we combine a novel high-frequency resonant amplifier topology, high- Q self-resonant coils, and a better understanding of high-frequency losses (C_{oss} losses and dynamic on-resistance) in WBG devices to showcase kW-scale 6.78 MHz WPT systems


Fig. 8: Schematic of the Class-D wireless dc-dc converter.

Fig. 9: Photograph of the 1 kW Class-D inverter and current-mode rectifier. Implemented inverter dimensions are 11.3 cm x 5.8 cm x 6 cm. Full-bridge current-mode diode rectifier (SiC Schottky diodes under clamping plate) dimensions are 6.7 cm x 3.7 cm x 3.7 cm.

Fig. 10: Class D wireless prototype experimental (a) drain and gate voltage waveform at 525 V_{in} and (b) efficiency performance across output power. Gate driving losses excluded. Power is varied by adjusting the input voltage.

with dc-dc efficiencies above 95 % and coil power densities as high as 30 W/cm². These benchmark-setting prototypes highlight the promise of high-frequency, high-power WPT.

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